

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
LIANHAI WU	09/28/2020
JING HAN	09/29/2020
HAIMING WANG	09/29/2020
JIE SHI	09/29/2020
HONGCHAO LI	09/29/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	LENOVO (BEIJING) LIMITED
<b>Street Address:</b>	6 SHANGDI WEST ROAD
<b>Internal Address:</b>	HAI DIAN DISTRICT
<b>City:</b>	BEIJING
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	100085
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17044945
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(801)531-1929
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	8019944646
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<b>Correspondent Name:</b>	KUNZLER BEAN & ADAMSON
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<b>ATTORNEY DOCKET NUMBER:</b>	SEC920170130-US-PCT
<b>NAME OF SUBMITTER:</b>	MICHAEL L. BARTHOLOMEW
<b>SIGNATURE:</b>	/Michael L. Bartholomew/
<b>DATE SIGNED:</b>	10/29/2020
<b>Total Attachments: 11</b>	

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**ASSIGNMENT AND AGREEMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **Lianhai Wu, Beijing, CHINA; Jing Han, Beijing, CHINA; Haiming Wang, Beijing, CHINA; Jie Shi, Beijing, CHINA;** and **Hongchao Li, Beijing, CHINA;** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **Lenovo (Beijing) Limited**, a corporation of China, having a place of business at 6 Shangdi West Road, Haidian District, Beijing, China 100085, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions described, illustrated and claimed in the following applications:

U.S. Application filed herein and entitled: **"METHOD AND APPARATUS FOR RELAY DISCOVERY"**; and

International Application **PCT/CN2018/081975**, filed on **April 4, 2018** entitled **"METHOD AND APPARATUS FOR RELAY DISCOVERY"**.

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize Assignee to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to other applications for Letters Patent on the inventions referenced in this Assignment and Agreement, and all rights, title and interest in and to all applications for Letters Patent in respect of the invention filed under any and all international conventions and treaties together with the entire right, title and interest in and to Letters Patent which may be issued upon the application(s) or any application(s) otherwise claiming priority thereto, and upon any divisions, extensions, continuations, reissues and/or re-examinations of such application(s).

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(1) Legal Name of Inventor: **Lianhai Wu**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(2) Legal Name of Inventor: **Jing Han**

Signature: Jing Han Date: 2020-9-29

(3) Legal Name of Inventor: **Haiming Wang**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(4) Legal Name of Inventor: **Jie Shi**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(5) Legal Name of Inventor: **Hongchao Li**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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(1) Legal Name of Inventor: **Lianhai Wu**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(2) Legal Name of Inventor: **Jing Han**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(3) Legal Name of Inventor: **Haiming Wang**

Signature: Haiming Wang Date: Sep, 29th, 2020

(4) Legal Name of Inventor: **Jie Shi**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(5) Legal Name of Inventor: **Hongchao Li**



Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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(1) Legal Name of Inventor: **Lianhai Wu**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(2) Legal Name of Inventor: **Jing Han**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(3) Legal Name of Inventor: **Haiming Wang**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(4) Legal Name of Inventor: **Jie Shi**

Signature: Jie Shi Date: 2020.9.29

(5) Legal Name of Inventor: **Hongchao Li**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(2) Legal Name of Inventor: **Jing Han**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(3) Legal Name of Inventor: **Haiming Wang**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(4) Legal Name of Inventor: **Jie Shi**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

(5) Legal Name of Inventor: **Hongchao Li**

Signature:  \_\_\_\_\_ Date: Sep 29th, 2020